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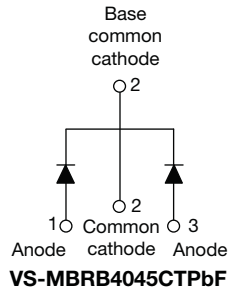
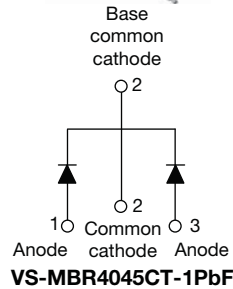
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## High Performance Schottky Rectifier, 2 x 20 A

**TO-263AB (D<sup>2</sup>PAK)**

**TO-262AA**

**FEATURES**

- 150 °C T<sub>J</sub> operation
- Low forward voltage drop
- High frequency operation
- Center tap TO-220, D<sup>2</sup>PAK and TO-262 packages
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Guard ring for enhanced ruggedness and long term reliability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)


**RoHS**  
 COMPLIANT  
 HALOGEN  
**FREE**
**PRODUCT SUMMARY**

Package	TO-263AB (D <sup>2</sup> PAK), TO-262AA
I <sub>F(AV)</sub>	40 A
V <sub>R</sub>	45 V
V <sub>F</sub> at I <sub>F</sub>	0.58 V
I <sub>RM</sub> max.	95 mA at 125 °C
T <sub>J</sub> max.	150 °C
Diode variation	Common cathode
E <sub>AS</sub>	20 mJ

**DESCRIPTION**

The center tap Schottky rectifier has been optimized for low reverse leakage at high temperature. The proprietary barrier technology allows for reliable operation up to 150 °C junction temperature. Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

**MAJOR RATINGS AND CHARACTERISTICS**

SYMBOL	CHARACTERISTICS	VALUES	UNITS
I <sub>F(AV)</sub>	Rectangular waveform (per device)	40	A
I <sub>FRM</sub>	T <sub>C</sub> = 118 °C (per leg)	40	
V <sub>RRM</sub>		45	V
I <sub>FSM</sub>	t <sub>p</sub> = 5 μs sine	900	A
V <sub>F</sub>	20 A <sub>pk</sub> , T <sub>J</sub> = 125 °C	0.58	V
T <sub>J</sub>	Range	-65 to +150	°C

**VOLTAGE RATINGS**

PARAMETER	SYMBOL	VS-MBRB4045CTPbF VS-MBR4045CT-1PbF	UNITS
Maximum DC reverse voltage	V <sub>R</sub>	45	V
Maximum working peak reverse voltage	V <sub>RWM</sub>		

**ABSOLUTE MAXIMUM RATINGS**

PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum average forward current per leg per device	I <sub>F(AV)</sub>	T <sub>C</sub> = 118 °C, rated V <sub>R</sub>	20	A
			40	
Peak repetitive forward current per leg	I <sub>FRM</sub>	Rated V <sub>R</sub> , square wave, 20 kHz, T <sub>C</sub> = 118 °C	40	
Maximum peak one cycle non-repetitive peak surge current per leg	I <sub>FSM</sub>	5 μs sine or 3 μs rect. pulse	900	
		10 ms sine or 6 ms rect. pulse	210	
Non-repetitive avalanche energy per leg	E <sub>AS</sub>	T <sub>J</sub> = 25 °C, I <sub>AS</sub> = 3 A, L = 4.4 mH	20	mJ
Repetitive avalanche current per leg	I <sub>AR</sub>	Current decaying linearly to zero in 1 μs Frequency limited by T <sub>J</sub> maximum V <sub>A</sub> = 1.5 x V <sub>R</sub> typical	3	A



ELECTRICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum forward voltage drop	$V_{FM}^{(1)}$	20 A	$T_J = 25\text{ }^\circ\text{C}$	0.60	V
		40 A		0.78	
		20 A	$T_J = 125\text{ }^\circ\text{C}$	0.58	
		40 A		0.75	
Maximum instantaneous reverse current	$I_{RM}^{(1)}$	$T_J = 25\text{ }^\circ\text{C}$	Rated DC voltage	1	mA
		$T_J = 100\text{ }^\circ\text{C}$		50	
		$T_J = 125\text{ }^\circ\text{C}$		95	
Maximum junction capacitance	$C_T$	$V_R = 5\text{ }V_{DC}$ (test signal range 100 kHz to 1 MHz), $25\text{ }^\circ\text{C}$		900	pF
Typical series inductance	$L_S$	Measured from top of terminal to mounting plane		8.0	nH
Maximum voltage rate of change	dV/dt	Rated $V_R$		10 000	V/ $\mu$ s

Note

(1) Pulse width < 300  $\mu$ s, duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum junction temperature range	$T_J$			-65 to +150	$^\circ\text{C}$
Maximum storage temperature range	$T_{Stg}$			-65 to +175	
Maximum thermal resistance, junction to case per leg	$R_{thJC}$	DC operation		1.5	$^\circ\text{C/W}$
Typical thermal resistance, case to heatsink	$R_{thCS}$	Mounting surface, smooth and greased (Only for TO-220)		0.50	
Maximum thermal resistance, junction to ambient	$R_{thJA}$	DC operation (For D <sup>2</sup> PAK and TO-262)		50	
Approximate weight				2	g
				0.07	oz.
Mounting torque	minimum	Non-lubricated threads		6 (5)	kgf · cm (lb · in)
	maximum			12 (10)	
Marking device		Case style D <sup>2</sup> PAK		MBRB4045CT	
		Case style TO-262		MBR4045CT-1	



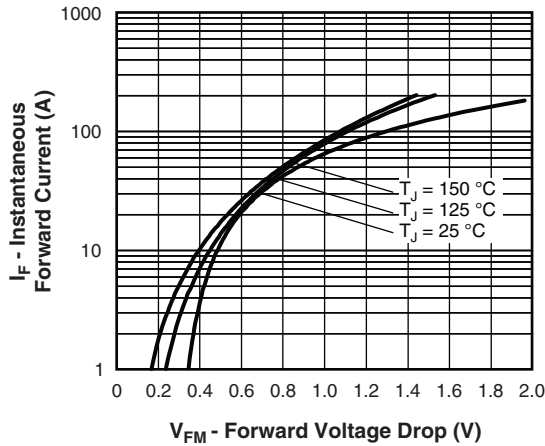


Fig. 1 - Maximum Forward Voltage Drop Characteristics (Per Leg)

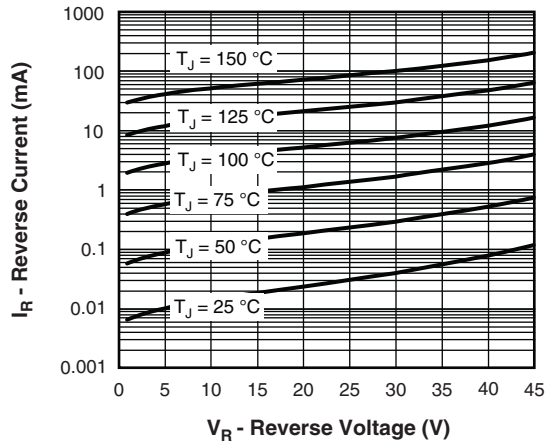


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage (Per Leg)

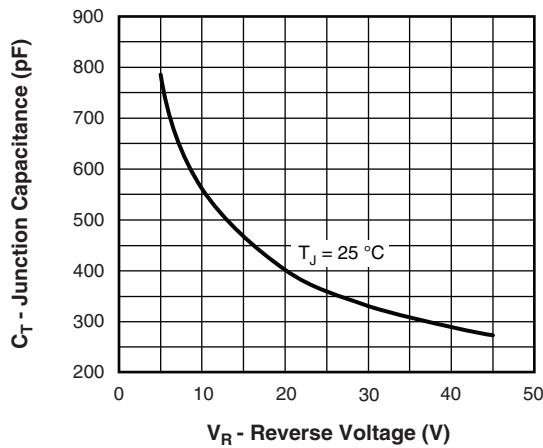


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

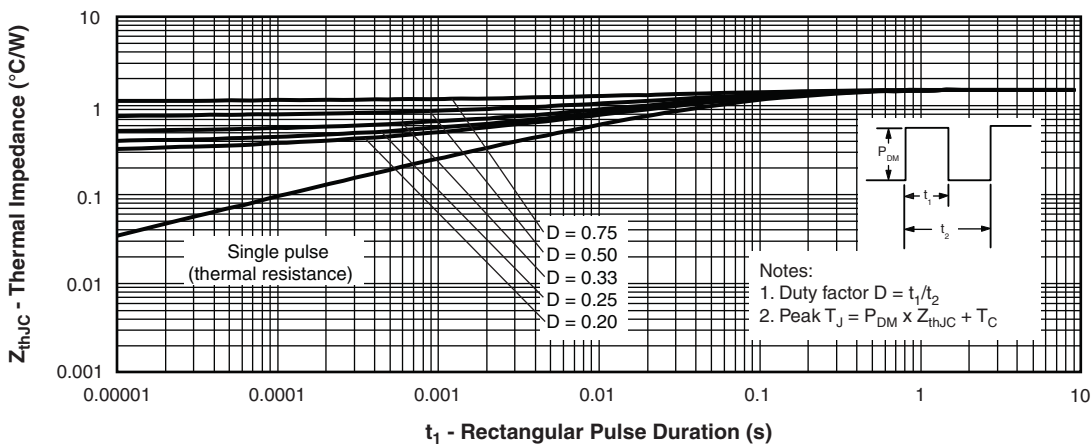


Fig. 4 - Maximum Thermal Impedance  $Z_{thJC}$  Characteristics (Per Leg)

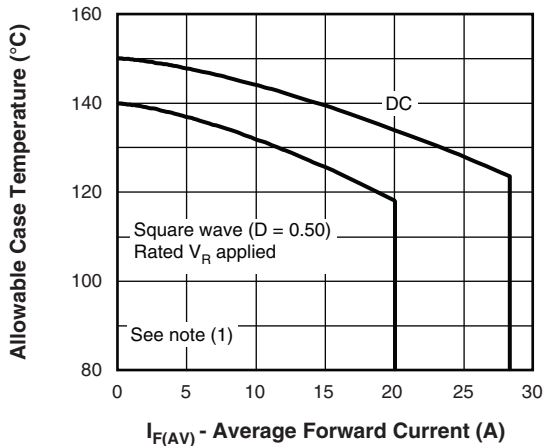


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

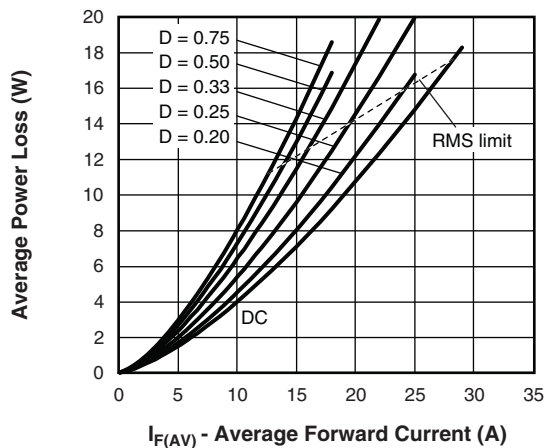


Fig. 6 - Forward Power Loss Characteristics

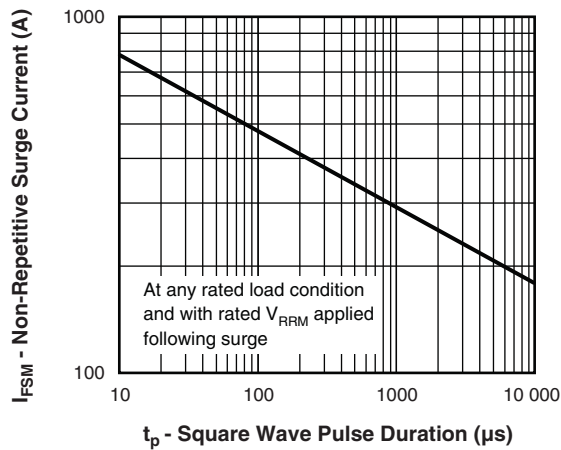


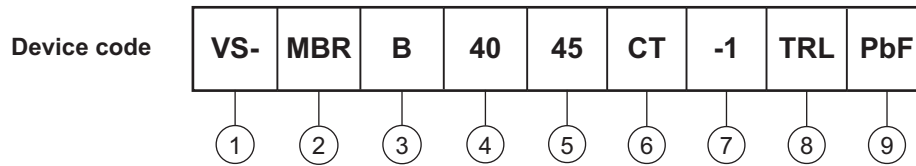
Fig. 7 - Maximum Non-Repetitive Surge Current (Per Leg)

**Note**

- (1) Formula used:  $T_C = T_J - (P_d + P_{d_{REV}}) \times R_{thJC}$   
 $P_d$  = forward power loss =  $I_{F(AV)} \times V_{FM}$  at  $(I_{F(AV)}/D)$  (see fig. 6);  
 $P_{d_{REV}}$  = inverse power loss =  $V_{R1} \times I_R (1 - D)$ ;  $I_R$  at  $V_{R1}$  = rated  $V_R$



## ORDERING INFORMATION TABLE



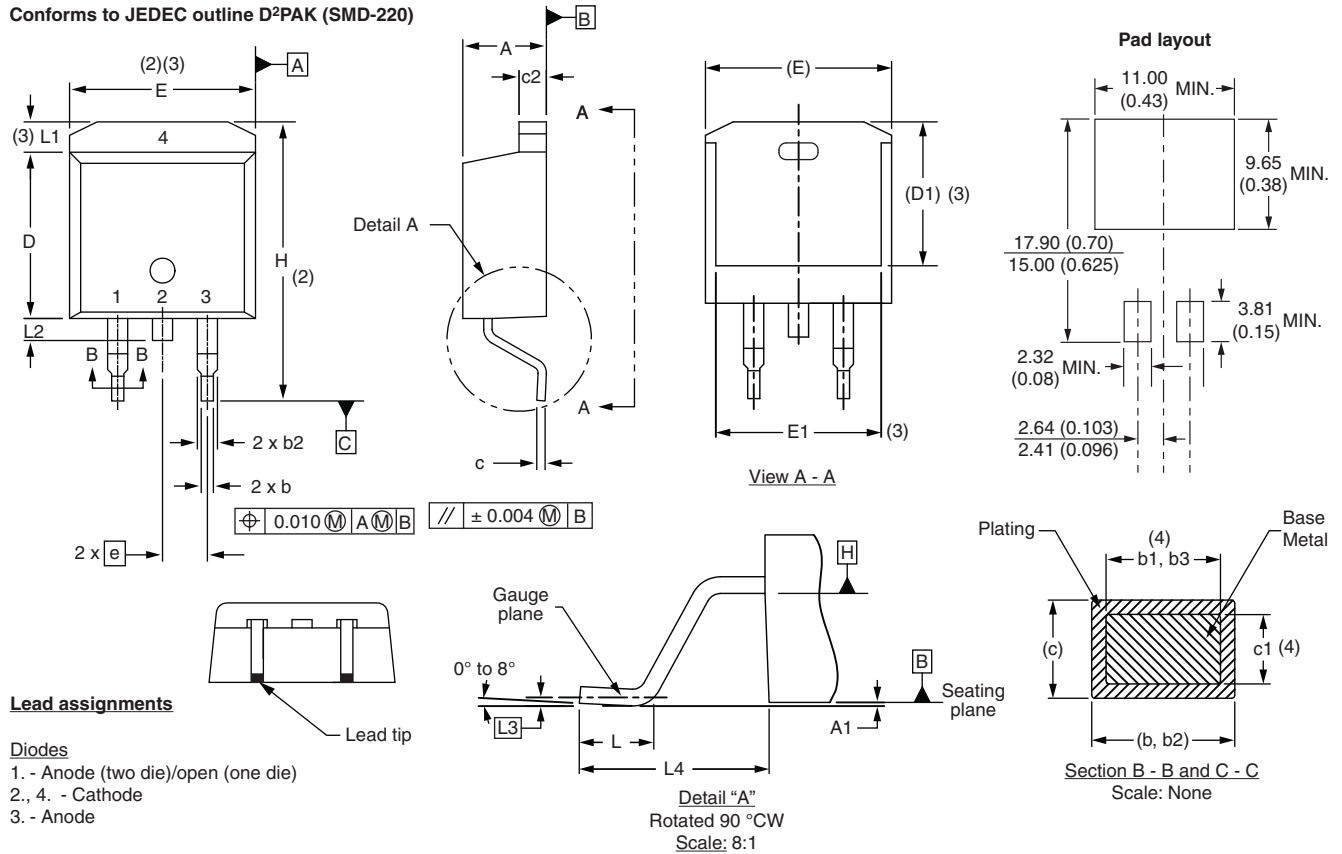
- 1** - Vishay Semiconductors product
- 2** - Essential part number
- 3** -
  - B = D<sup>2</sup>PAK **7** None
  - None = TO-262 **7** = -1
- 4** - Current rating (40 = 40 A)
- 5** - Voltage rating (45 = 45 V)
- 6** - CT = essential part number
- 7** -
  - None = D<sup>2</sup>PAK **3** = B
  - -1 = TO-262 **3** None
- 8** -
  - None = tube (50 pieces)
  - TRL = tape and reel (left oriented - for D<sup>2</sup>PAK only)
  - TRR = tape and reel (right oriented - for D<sup>2</sup>PAK only)
- 9** -
  - PbF = lead (Pb)-free (for TO-262 and D<sup>2</sup>PAK tube)
  - P = lead (Pb)-free (for D<sup>2</sup>PAK TRR and TRL)

LINKS TO RELATED DOCUMENTS	
Dimensions	<a href="http://www.vishay.com/doc?95014">www.vishay.com/doc?95014</a>
Part marking information	<a href="http://www.vishay.com/doc?95008">www.vishay.com/doc?95008</a>
Packaging information	<a href="http://www.vishay.com/doc?95032">www.vishay.com/doc?95032</a>
SPICE model	<a href="http://www.vishay.com/doc?95296">www.vishay.com/doc?95296</a>

## D<sup>2</sup>PAK, TO-262

### DIMENSIONS - D<sup>2</sup>PAK in millimeters and inches

Conforms to JEDEC outline D<sup>2</sup>PAK (SMD-220)



SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	
A	4.06	4.83	0.160	0.190	
A1	0.00	0.254	0.000	0.010	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	4
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	4
c	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	4
c2	1.14	1.65	0.045	0.065	
D	8.51	9.65	0.335	0.380	2

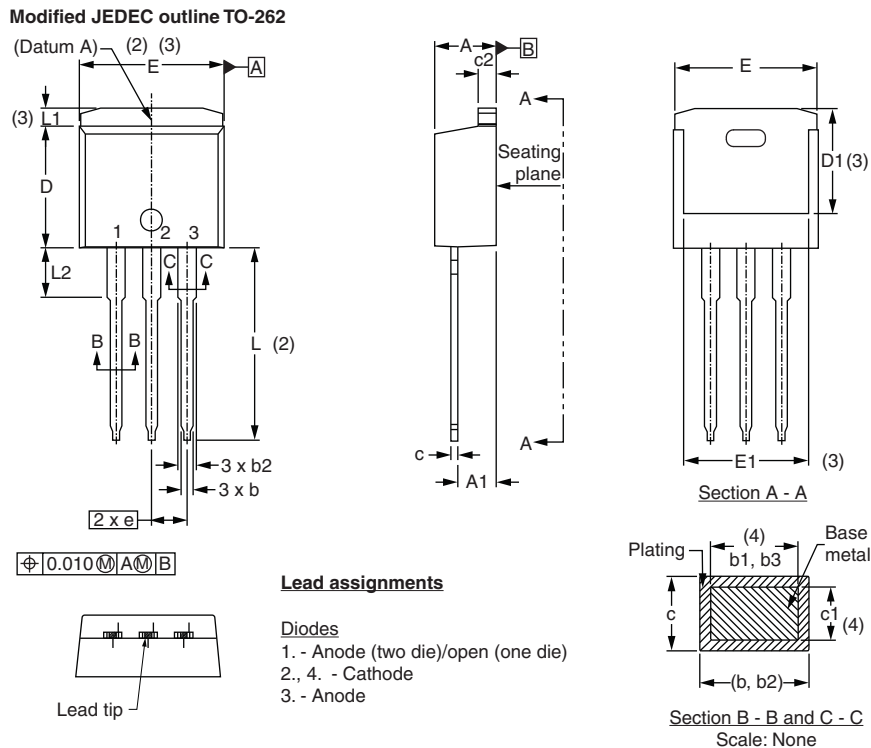
SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	
D1	6.86	8.00	0.270	0.315	3
E	9.65	10.67	0.380	0.420	2, 3
E1	7.90	8.80	0.311	0.346	3
e	2.54 BSC		0.100 BSC		
H	14.61	15.88	0.575	0.625	
L	1.78	2.79	0.070	0.110	
L1	-	1.65	-	0.066	3
L2	1.27	1.78	0.050	0.070	
L3	0.25 BSC		0.010 BSC		
L4	4.78	5.28	0.188	0.208	

#### Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inch

- (7) Outline conforms to JEDEC outline TO-263AB

## DIMENSIONS - TO-262 in millimeters and inches



SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	
A	4.06	4.83	0.160	0.190	
A1	2.03	3.02	0.080	0.119	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	4
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	4
c	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	4
c2	1.14	1.65	0.045	0.065	
D	8.51	9.65	0.335	0.380	2
D1	6.86	8.00	0.270	0.315	3
E	9.65	10.67	0.380	0.420	2, 3
E1	7.90	8.80	0.311	0.346	3
e	2.54 BSC		0.100 BSC		
L	13.46	14.10	0.530	0.555	
L1	-	1.65	-	0.065	3
L2	3.56	3.71	0.140	0.146	

### Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Controlling dimension: inches
- (6) Outline conform to JEDEC TO-262 except A1 (maximum), b (minimum) and D1 (minimum) where dimensions derived the actual package outline





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